



N- and P-Channel 12-V (D-S) MOSFET

PRODUCT SUMMARY				
	V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)
N-Channel	12	0.034 at V _{GS} = 4.5 V	4.5 ^a	5.6 nC
		0.040 at V _{GS} = 2.5 V	4.5 ^a	
		0.050 at V _{GS} = 1.8 V	4.5 ^a	
		0.070 at V _{GS} = 1.5 V	4.5 ^a	
P-Channel	- 12	0.059 at V _{GS} = - 4.5 V	- 4.5 ^a	7.8 nC
		0.081 at V _{GS} = - 2.5 V	- 4.5 ^a	
		0.115 at V _{GS} = - 1.8 V	- 4.5 ^a	
		0.215 at V _{GS} = - 1.5 V	- 1.5	

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFETs
- Typical ESD Protection: N-Channel 1500 V
P-Channel 1000 V
- 100 % R_G Tested
- Compliant to RoHS Directive 2002/95/EC

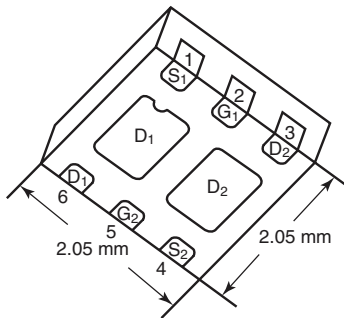


RoHS
COMPLIANT
HALOGEN
FREE

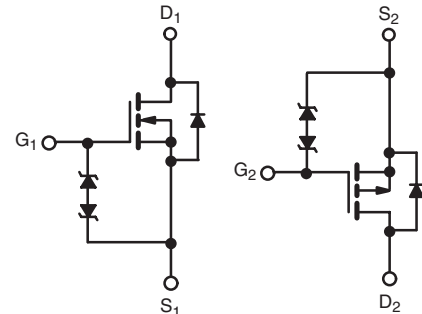
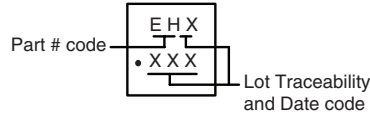
APPLICATIONS

- Load Switch for Portable Devices
- DC/DC Converters

PowerPAK® SC-70-6 Dual



Marking Code



N-Channel MOSFET

P-Channel MOSFET

Ordering Information: SiA533EDJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted					
Parameter	Symbol	N-Channel	P-Channel	Unit	
Drain-Source Voltage	V _{DS}	12	- 12	V	
Gate-Source Voltage	V _{GS}	± 8			
Continuous Drain Current (T _J = 150 °C)	I _D	T _C = 25 °C	4.5 ^a	- 4.5 ^a	A
		T _C = 70 °C	4.5 ^a	- 4.5 ^a	
		T _A = 25 °C	4.5 ^{a, b, c}	- 4.5 ^{a, b, c}	
		T _A = 70 °C	4.5 ^{a, b, c}	- 3.7 ^{b, c}	
Pulsed Drain Current	I _{DM}	20	- 15		
Source Drain Current Diode Current	I _S	T _C = 25 °C	4.5 ^a	- 4.5 ^a	
		T _A = 25 °C	1.6 ^{b, c}	- 1.6 ^{b, c}	
Maximum Power Dissipation	P _D	T _C = 25 °C	7.8	7.8	W
		T _C = 70 °C	5	5	
		T _A = 25 °C	1.9 ^{b, c}	1.9 ^{b, c}	
		T _A = 70 °C	1.2 ^{b, c}	1.2 ^{b, c}	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150		°C	
Soldering Recommendations (Peak Temperature) ^{d, e}		260			

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	N-Channel		P-Channel		Unit	
		Typ.	Max.	Typ.	Max.		
Maximum Junction-to-Ambient ^{b, f}	$t \leq 5 \text{ s}$	R_{thJA}	52	65	52	65	°C/W
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	12.5	16	12.5	16	

Notes:

- a. Package limited.
b. Surface mounted on 1" x 1" FR4 board.
c. $t = 5 \text{ s}$.
d. See solder profile (www.vishay.com/ppg?73257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
f. Maximum under steady state conditions is 110 °C/W.

SPECIFICATIONS $T_J = 25 \text{ }^\circ\text{C}$, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \text{ } \mu\text{A}$	N-Ch	12		V	
		$V_{GS} = 0 \text{ V}, I_D = -250 \text{ } \mu\text{A}$	P-Ch	-12			
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	$I_D = 250 \text{ } \mu\text{A}$	N-Ch		19	mV/°C	
		$I_D = -250 \text{ } \mu\text{A}$	P-Ch		-5.7		
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = 250 \text{ } \mu\text{A}$	N-Ch		-2.7		
		$I_D = -250 \text{ } \mu\text{A}$	P-Ch		1.7		
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250 \text{ } \mu\text{A}$	N-Ch	0.4	1.0	V	
		$V_{DS} = V_{GS}, I_D = -250 \text{ } \mu\text{A}$	P-Ch	-0.4	-1.0		
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$	N-Ch		± 0.5	μA	
		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$	N-Ch		± 5		
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 12 \text{ V}, V_{GS} = 0 \text{ V}$	N-Ch		1		
		$V_{DS} = -12 \text{ V}, V_{GS} = 0 \text{ V}$	P-Ch		-1		
		$V_{DS} = 12 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55 \text{ }^\circ\text{C}$	N-Ch		10		
		$V_{DS} = -12 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55 \text{ }^\circ\text{C}$	P-Ch		-10		
On-State Drain Current ^b	$I_{D(on)}$	$V_{DS} \geq 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	N-Ch	10		A	
		$V_{DS} \leq -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	P-Ch	-10			
Drain-Source On-State Resistance ^b	$R_{DS(on)}$	$V_{GS} = 4.5 \text{ V}, I_D = 4.6 \text{ A}$	N-Ch		0.028	0.034	Ω
		$V_{GS} = -4.5 \text{ V}, I_D = -3.6 \text{ A}$	P-Ch		0.048	0.059	
		$V_{GS} = 2.5 \text{ V}, I_D = 4.2 \text{ A}$	N-Ch		0.032	0.040	
		$V_{GS} = -2.5 \text{ V}, I_D = -3.1 \text{ A}$	P-Ch		0.066	0.081	
		$V_{GS} = 1.8 \text{ V}, I_D = 3.8 \text{ A}$	N-Ch		0.038	0.050	
		$V_{GS} = -1.8 \text{ V}, I_D = -2.6 \text{ A}$	P-Ch		0.093	0.115	
		$V_{GS} = 1.5 \text{ V}, I_D = 1.5 \text{ A}$	N-Ch		0.045	0.070	
		$V_{GS} = -1.5 \text{ V}, I_D = -0.5 \text{ A}$	P-Ch		0.120	0.215	
Forward Transconductance ^b	g_{fs}	$V_{DS} = 6 \text{ V}, I_D = 4.6 \text{ A}$	N-Ch		21	S	
		$V_{DS} = -6 \text{ V}, I_D = -3.6 \text{ A}$	P-Ch		11		
Input Capacitance	C_{iss}	N-Channel $V_{DS} = 6 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	N-Ch		420	pF	
Output Capacitance	C_{oss}		P-Ch		545		
			N-Ch		100		
Reverse Transfer Capacitance	C_{rss}		P-Ch		192		
		N-Ch		62			
			P-Ch		175		



SPECIFICATIONS $T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit	
Dynamic^a							
Total Gate Charge	Q_g	$V_{DS} = 10\text{ V}, V_{GS} = 10\text{ V}, I_D = 5.9\text{ A}$	N-Ch		10	15	nC
		$V_{DS} = -10\text{ V}, V_{GS} = -10\text{ V}, I_D = -4.7\text{ A}$	P-Ch		13	20	
		$V_{DS} = 10\text{ V}, V_{GS} = 4.5\text{ V}, I_D = 5.9\text{ A}$	N-Channel		5.6	8.5	
			P-Channel		7.8	12	
Gate-Source Charge	Q_{gs}	$V_{DS} = 10\text{ V}, V_{GS} = 4.5\text{ V}, I_D = 5.9\text{ A}$	N-Channel		0.7		
			P-Channel		1.3		
Gate-Drain Charge	Q_{gd}	$V_{DS} = -10\text{ V}, V_{GS} = -4.5\text{ V}, I_D = -4.7\text{ A}$	N-Channel		0.85		
			P-Channel		2.3		
Gate Resistance	R_g	$f = 1\text{ MHz}$	N-Channel	0.7	3.5	7	Ω
			P-Channel	1.4	7	14	

Notes:

a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.

SPECIFICATIONS $T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit	
Dynamic^a							
Turn-On Delay Time	$t_{d(on)}$	N-Channel $V_{DD} = 6\text{ V}, R_L = 1.3\text{ }\Omega$ $I_D \cong 4.8\text{ A}, V_{GEN} = 4.5\text{ V}, R_g = 1\text{ }\Omega$ P-Channel $V_{DD} = -6\text{ V}, R_L = 1.6\text{ }\Omega$ $I_D \cong -3.7\text{ A}, V_{GEN} = -4.5\text{ V}, R_g = 1\text{ }\Omega$	N-Ch		10	15	ns
			P-Ch		15	25	
Rise Time	t_r		N-Ch		10	15	
			P-Ch		15	25	
Turn-Off Delay Time	$t_{d(off)}$		N-Ch		20	30	
			P-Ch		25	40	
Fall Time	t_f		N-Ch		10	15	
			P-Ch		10	15	
Turn-On Delay Time	$t_{d(on)}$	N-Channel $V_{DD} = 6\text{ V}, R_L = 1.3\text{ }\Omega$ $I_D \cong 4.8\text{ A}, V_{GEN} = 8\text{ V}, R_g = 1\text{ }\Omega$ P-Channel $V_{DD} = -6\text{ V}, R_L = 1.6\text{ }\Omega$ $I_D \cong -3.7\text{ A}, V_{GEN} = -8\text{ V}, R_g = 1\text{ }\Omega$	N-Ch		5	10	
			P-Ch		5	10	
Rise Time	t_r		N-Ch		10	15	
			P-Ch		10	15	
Turn-Off Delay Time	$t_{d(off)}$		N-Ch		20	30	
			P-Ch		25	40	
Fall Time	t_f		N-Ch		10	15	
			P-Ch		10	15	
Drain-Source Body Diode Characteristics							
Continuous Source-Drain Diode Current	I_S	$T_C = 25\text{ }^\circ\text{C}$	N-Ch			4.5	A
			P-Ch			-4.5	
Pulse Diode Forward Current ^a	I_{SM}		N-Ch			20	A
			P-Ch			-15	
Body Diode Voltage	V_{SD}	$I_S = 4.8\text{ A}, V_{GS} = 0\text{ V}$	N-Ch		0.85	1.2	V
			P-Ch		-0.87	-1.2	
Body Diode Reverse Recovery Time	t_{rr}	N-Channel $I_F = 4.4\text{ A}, dl/dt = 100\text{ A}/\mu\text{s}, T_J = 25\text{ }^\circ\text{C}$ P-Channel $I_F = -3.7\text{ A}, dl/dt = -100\text{ A}/\mu\text{s}, T_J = 25\text{ }^\circ\text{C}$	N-Ch		10	20	ns
			P-Ch		25	50	
Body Diode Reverse Recovery Charge	Q_{rr}		N-Ch		5	10	nC
			P-Ch		10	20	
Reverse Recovery Fall Time	t_a		N-Ch		5.5		ns
			P-Ch		17		
Reverse Recovery Rise Time	t_b		N-Ch		4.5		
			P-Ch		8		

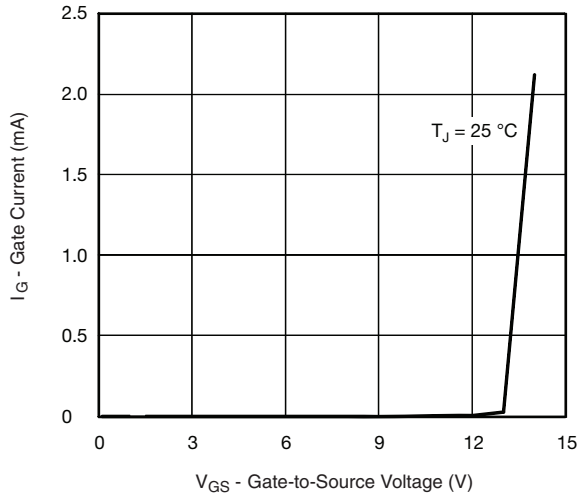
Notes:

a. Guaranteed by design, not subject to production testing.

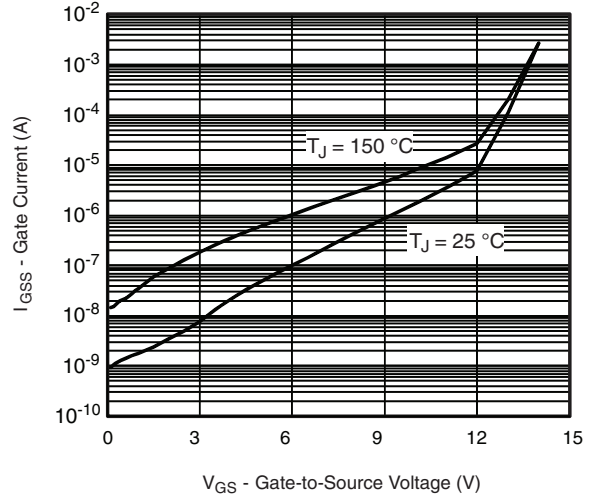
b. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

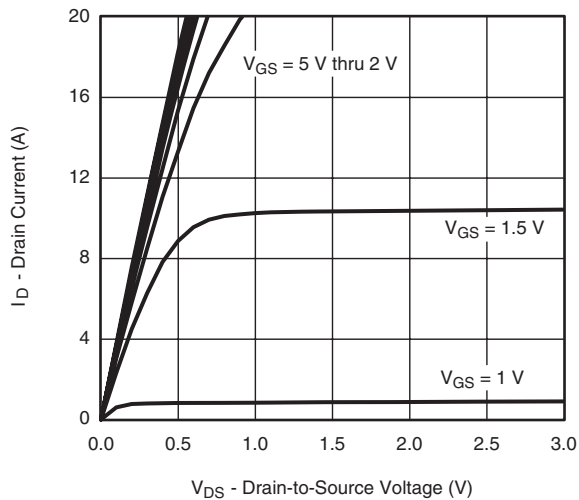
N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



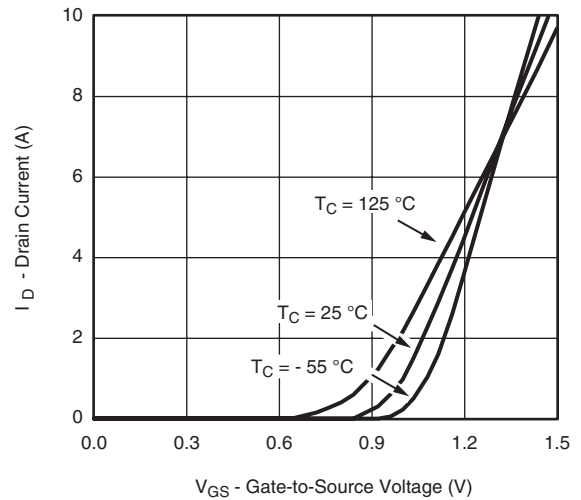
Gate Current vs. Gate-Source Voltage



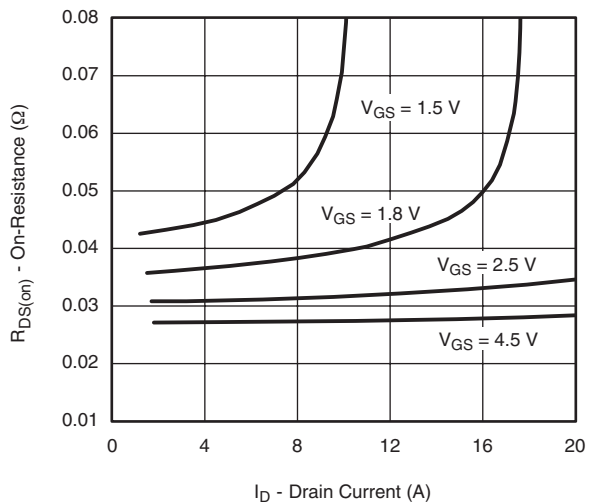
Gate Current vs. Gate-Source Voltage



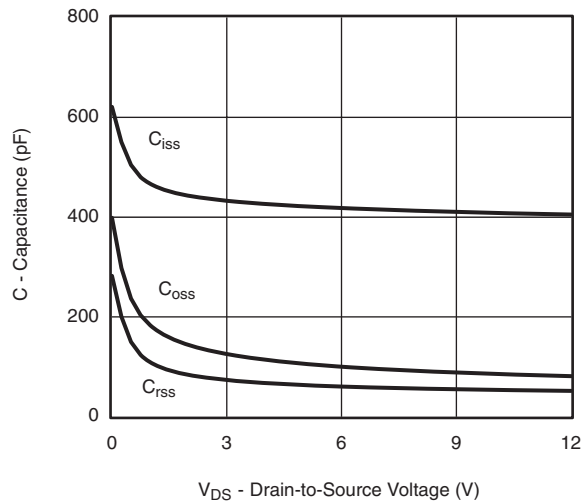
Output Characteristics



Transfer Characteristics



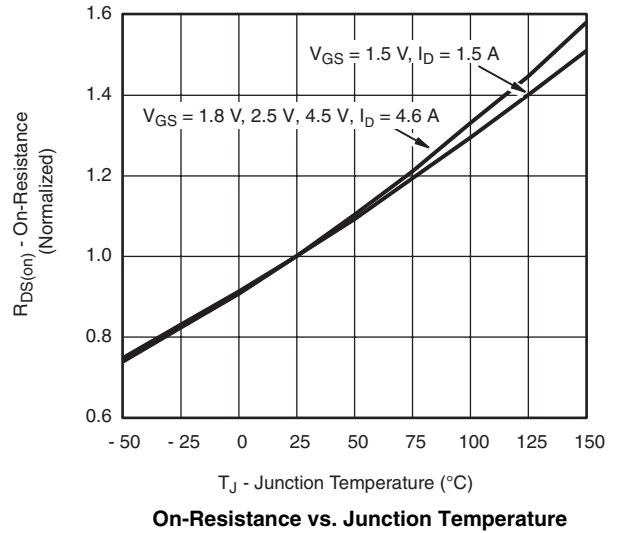
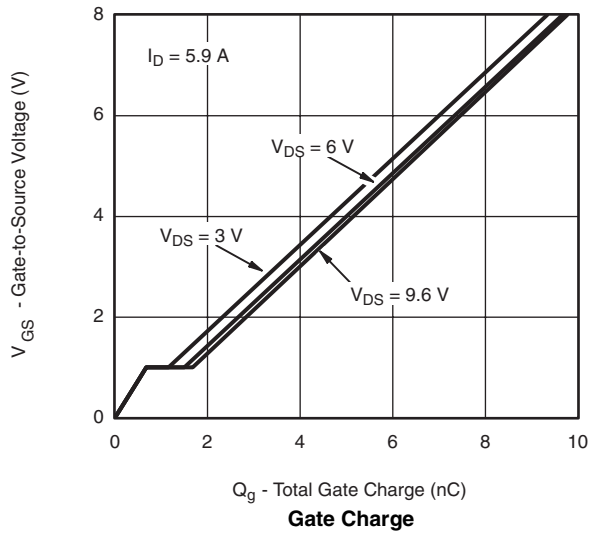
On-Resistance vs. Drain Current and Gate Voltage



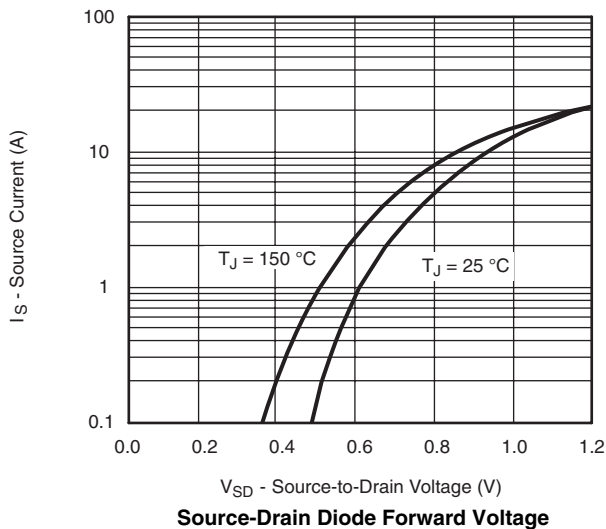
Capacitance



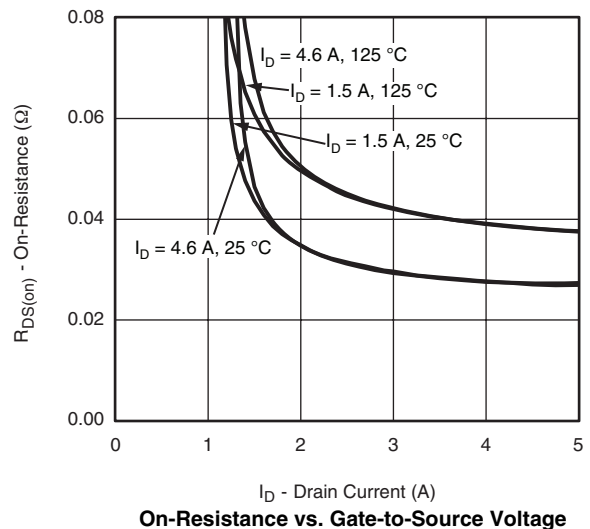
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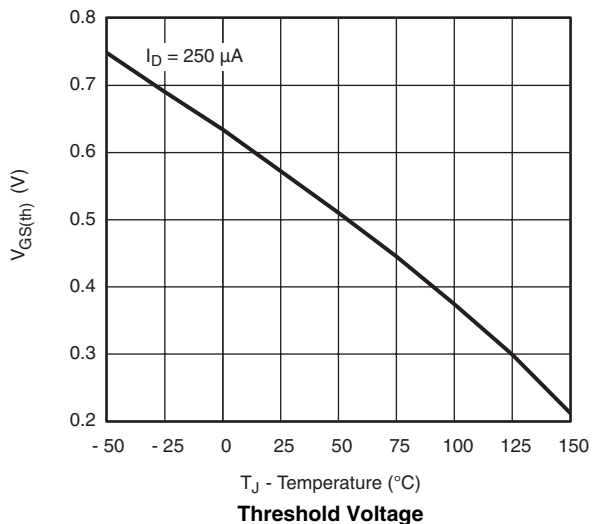
On-Resistance vs. Junction Temperature



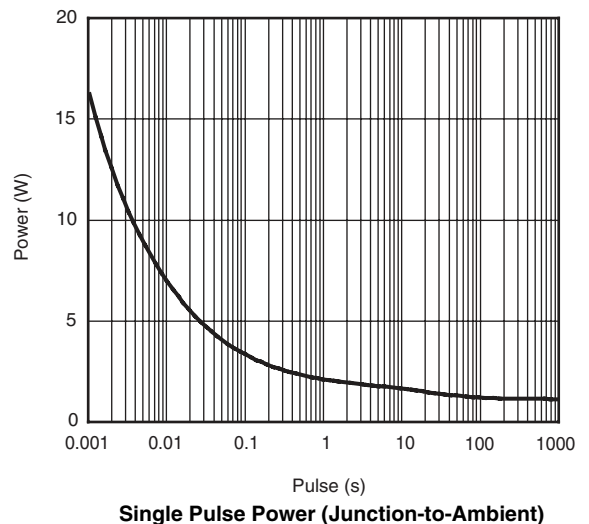
Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



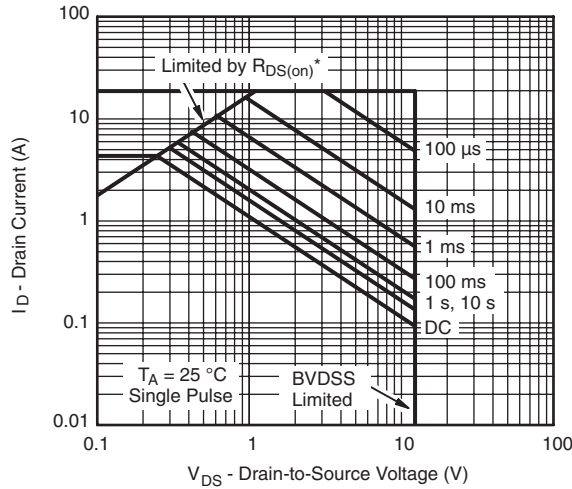
Threshold Voltage



Single Pulse Power (Junction-to-Ambient)

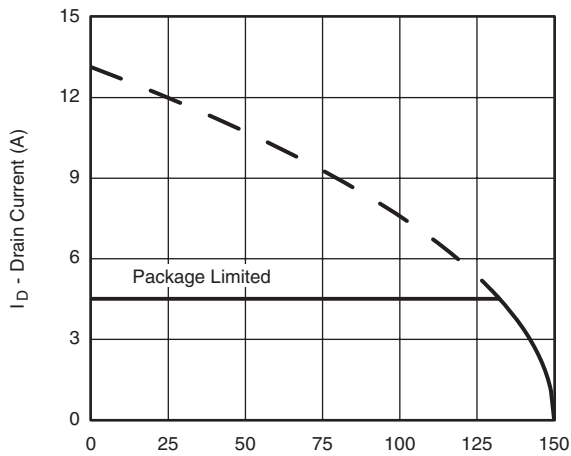


N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



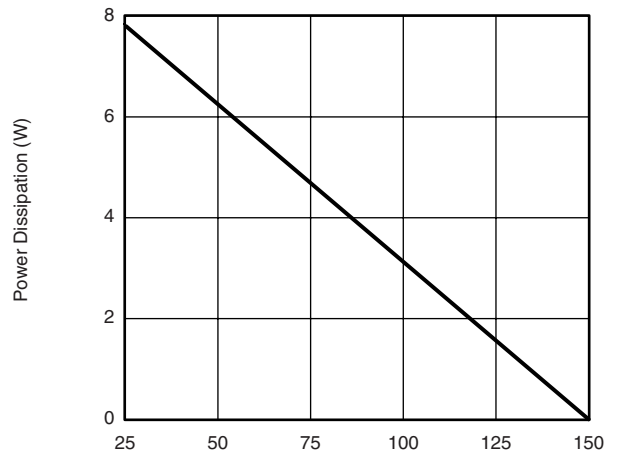
* $V_{GS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient



T_C - Case Temperature ($^\circ\text{C}$)

Current Derating*



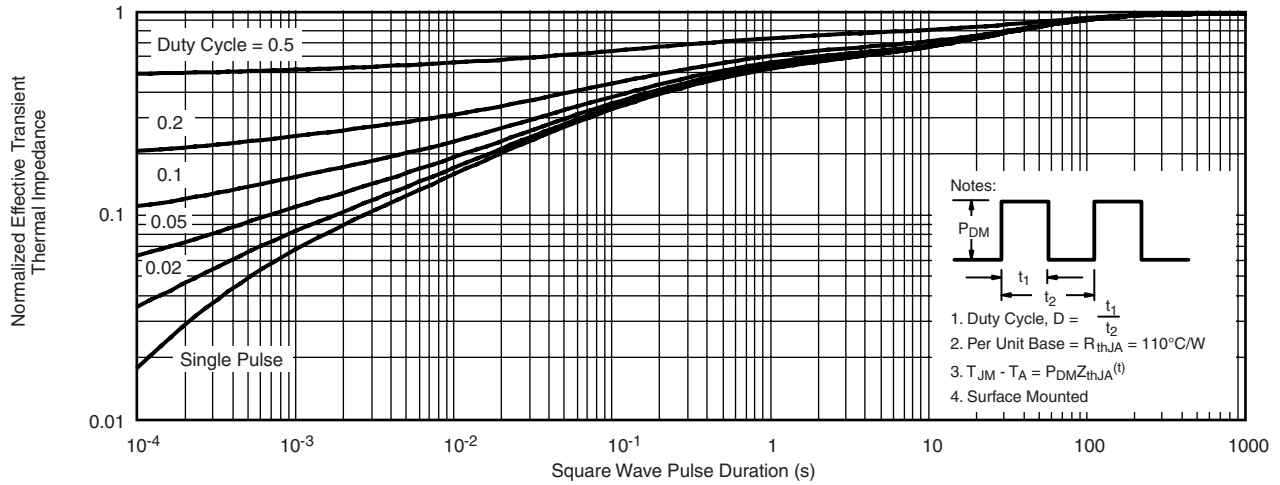
T_C - Case Temperature ($^\circ\text{C}$)

Power Derating

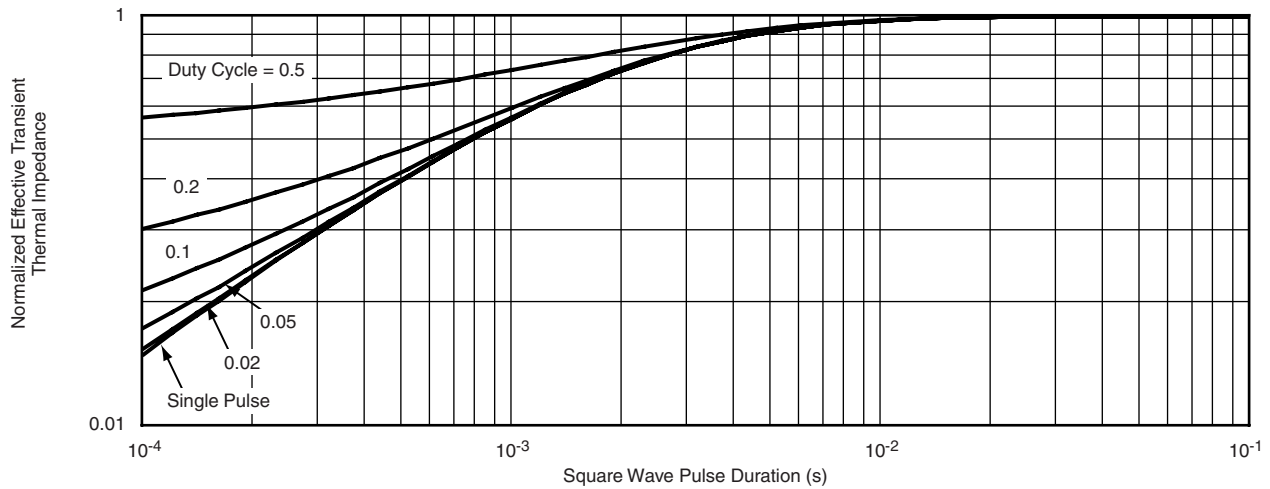
* The power dissipation P_D is based on $T_{J(max)} = 150^\circ\text{C}$, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



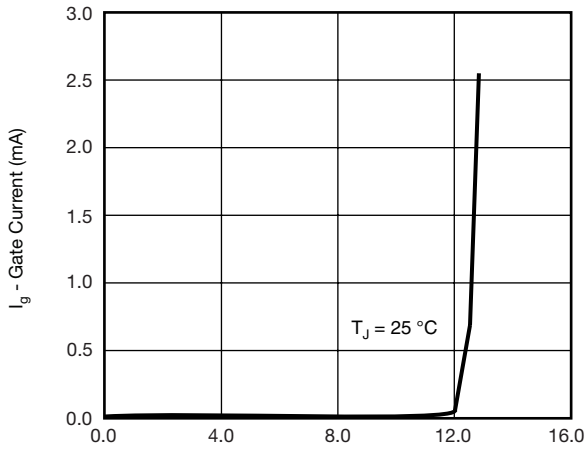
Normalized Thermal Transient Impedance, Junction-to-Case

SiA533EDJ

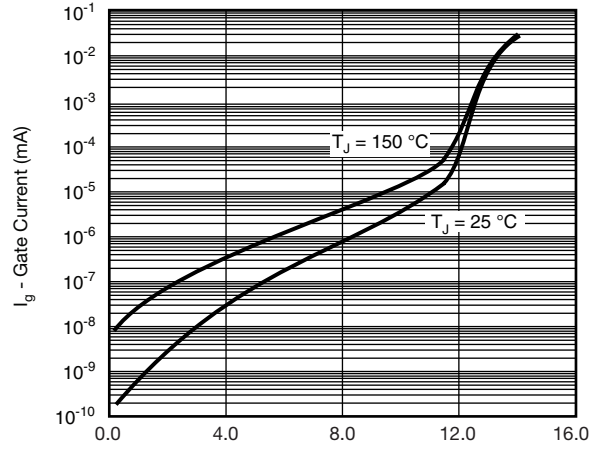
Vishay Siliconix



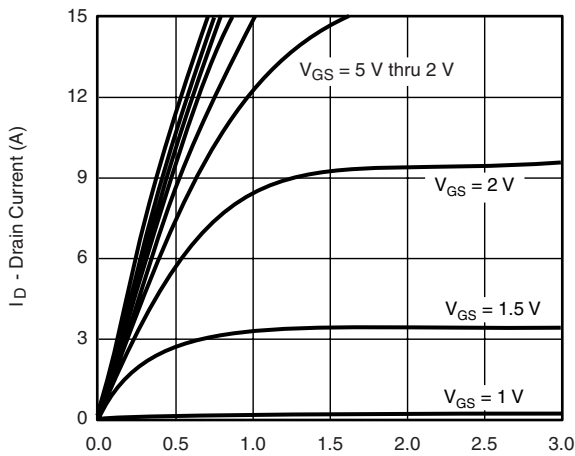
P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



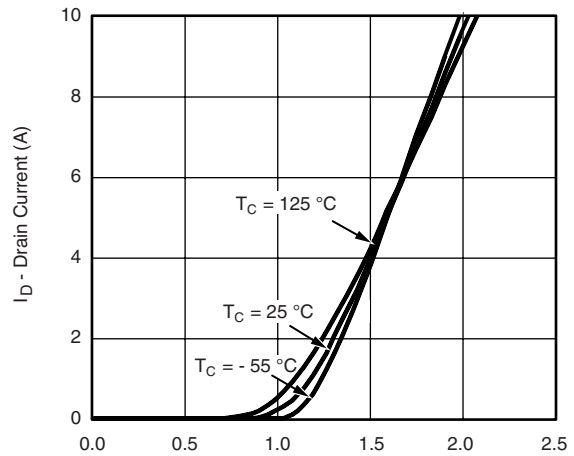
V_{GS} - Gate-to-Source Voltage (V)
Gate Current vs. Gate-Source Voltage



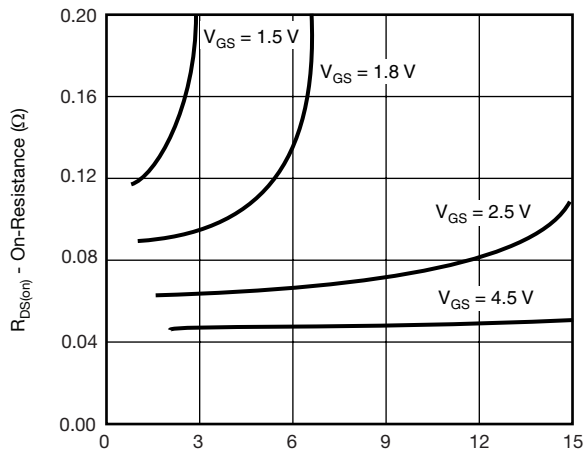
V_{GS} - Gate-to-Source Voltage (V)
Gate Current vs. Gate-Source Voltage



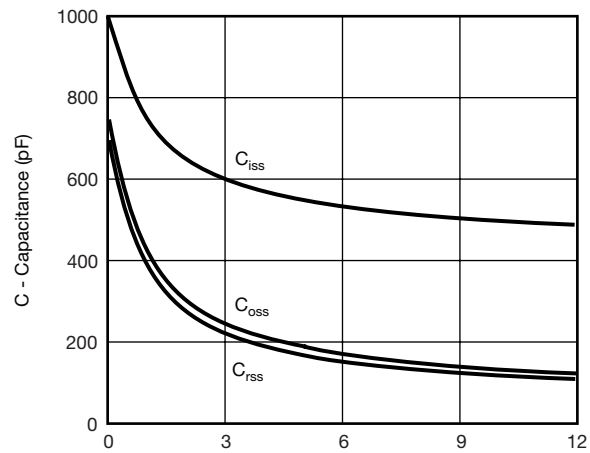
V_{DS} - Drain-to-Source Voltage (V)
Output Characteristics



V_{GS} - Gate-to-Source Voltage (V)
Transfer Characteristics



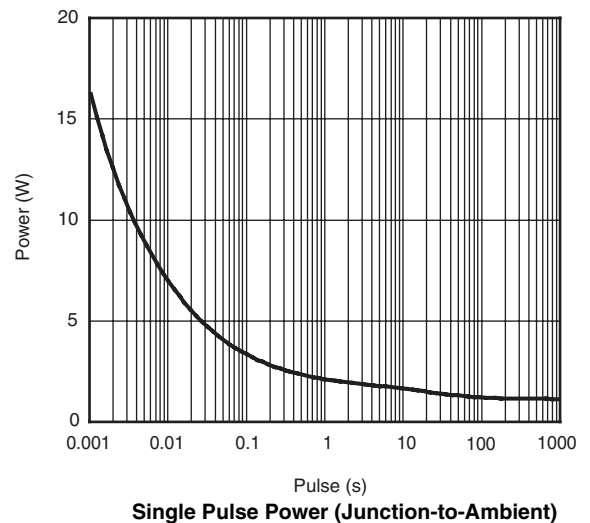
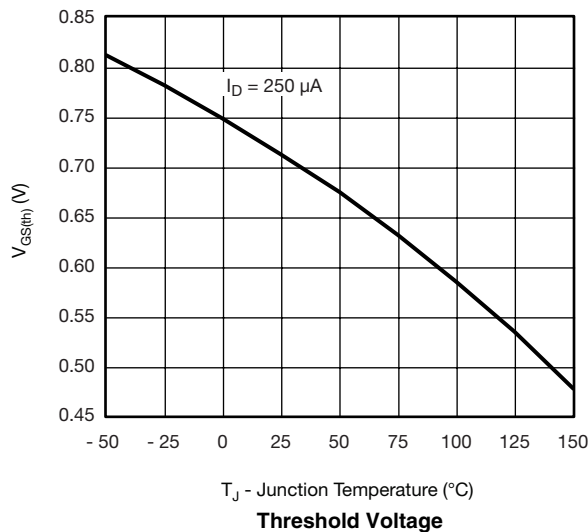
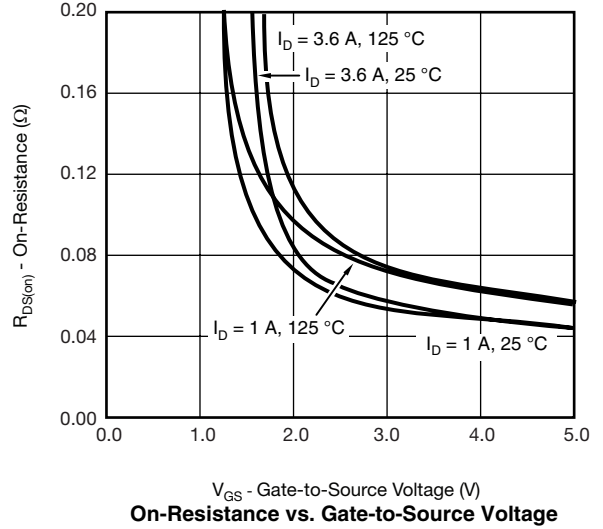
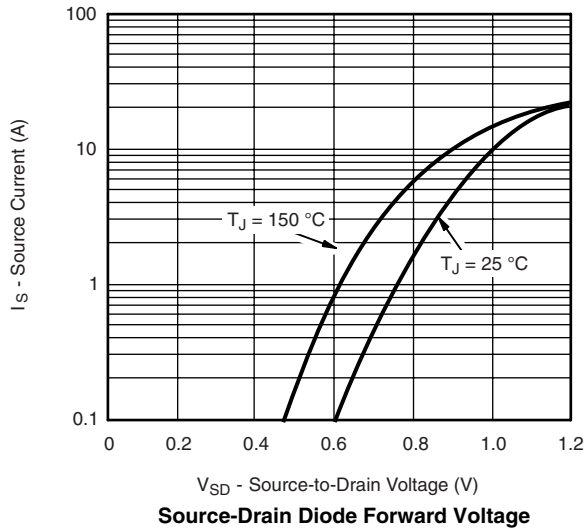
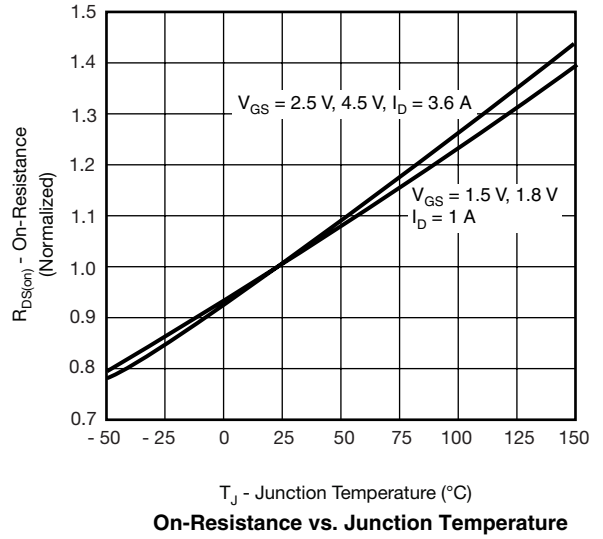
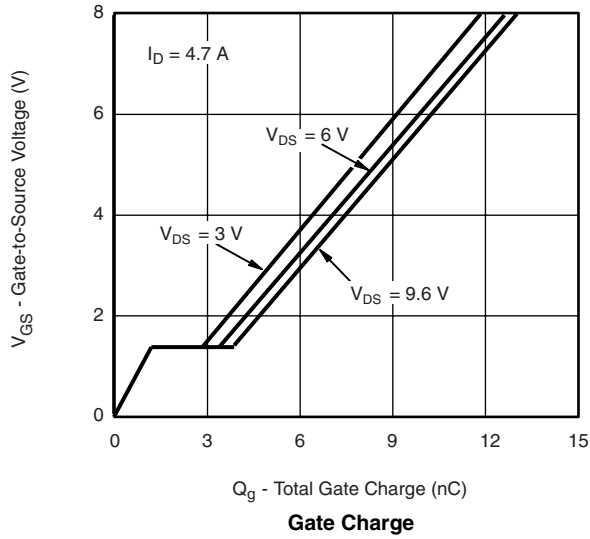
I_D - Drain Current (A)
On-Resistance vs. Drain Current and Gate Voltage



V_{DS} - Drain-to-Source Voltage (V)
Capacitance



P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

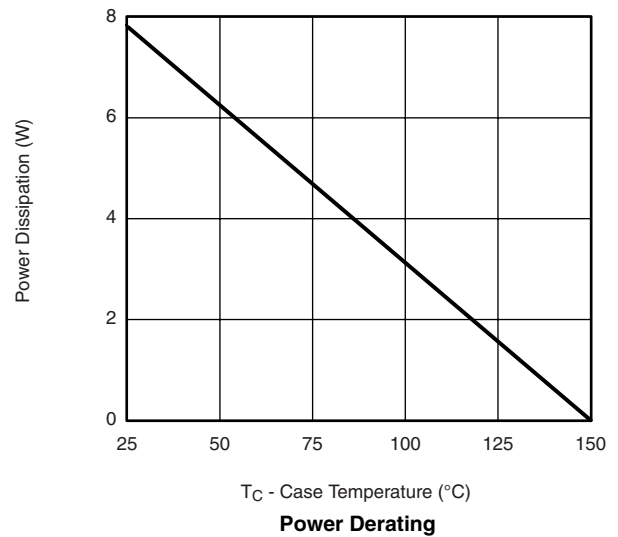
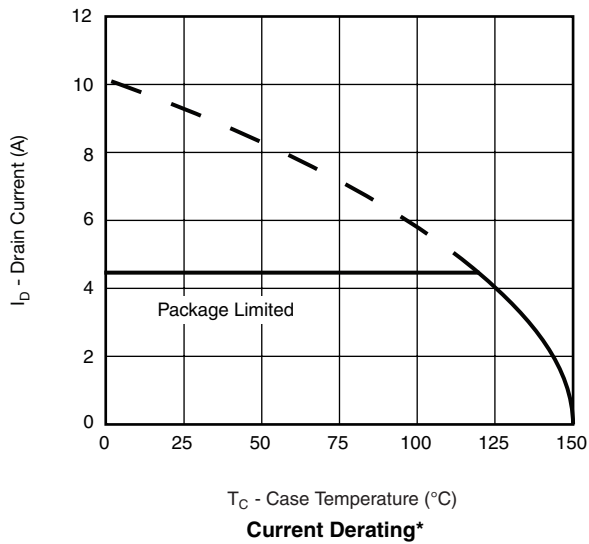
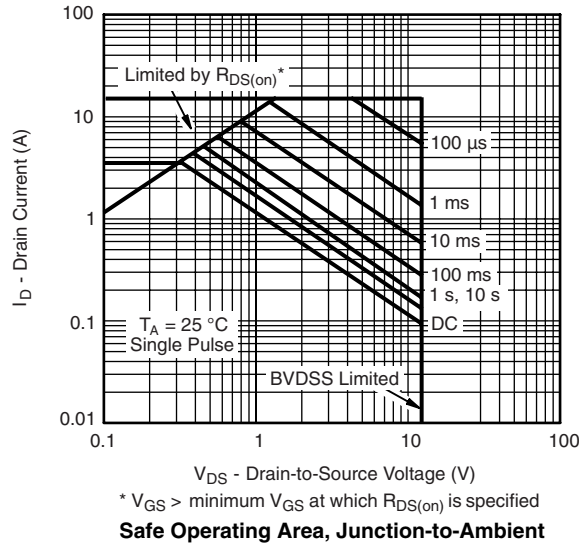


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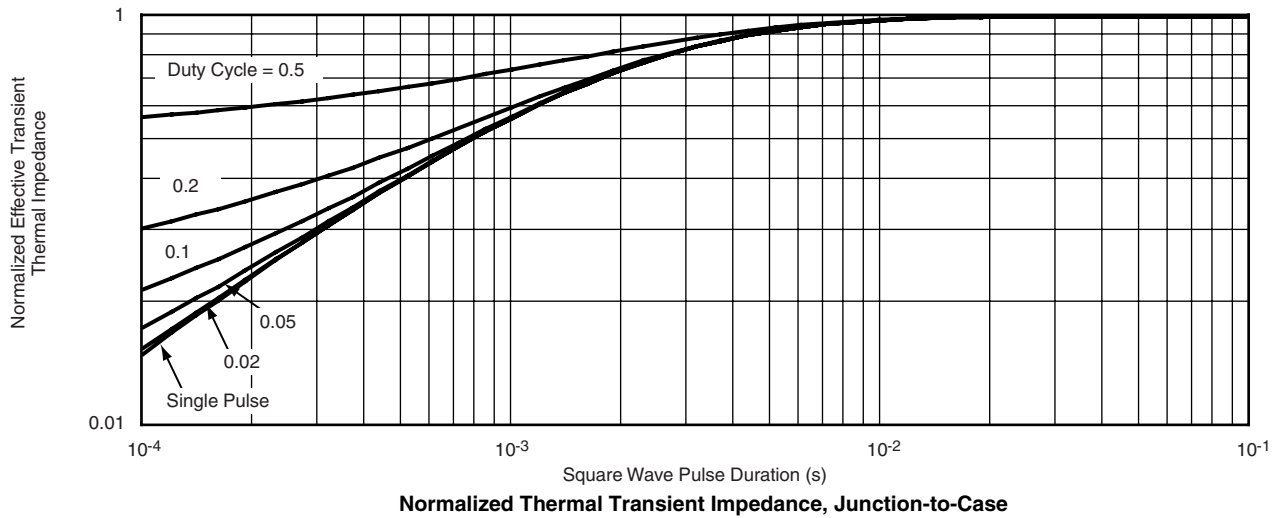
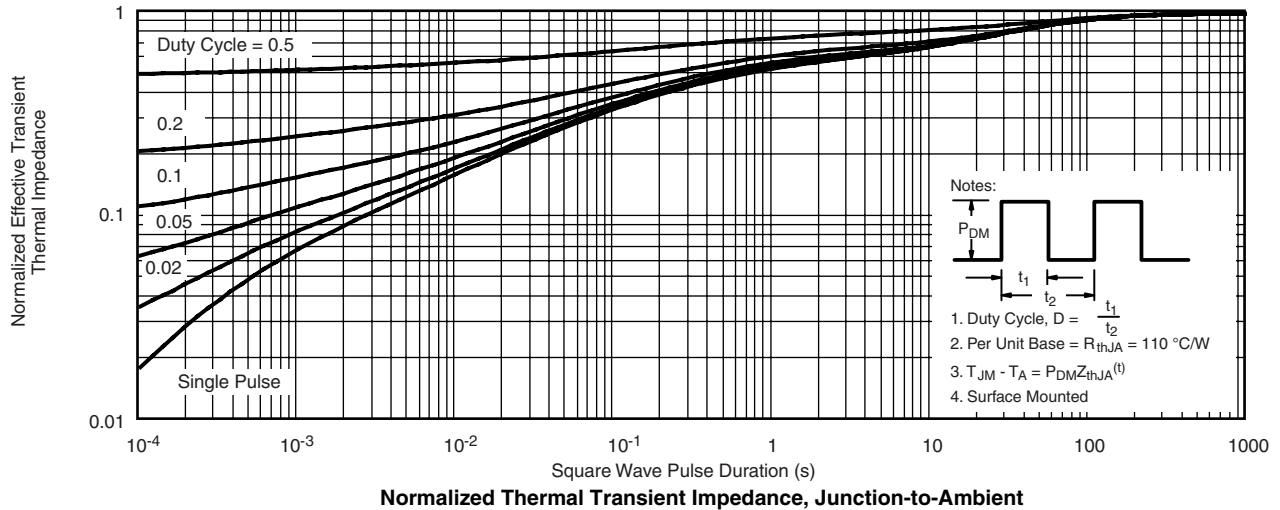
P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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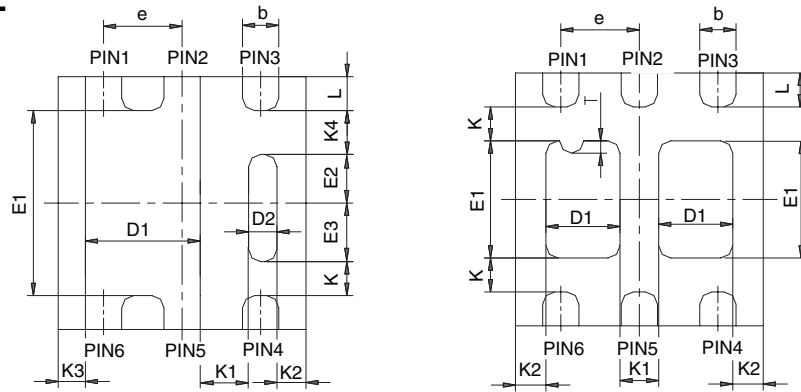
P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?65706.

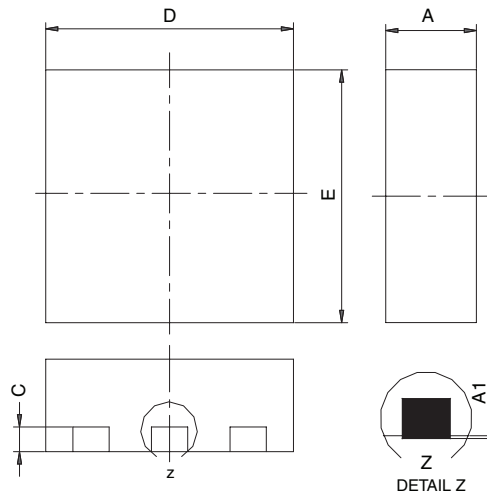


PowerPAK® SC70-6L



BACKSIDE VIEW OF SINGLE

BACKSIDE VIEW OF DUAL

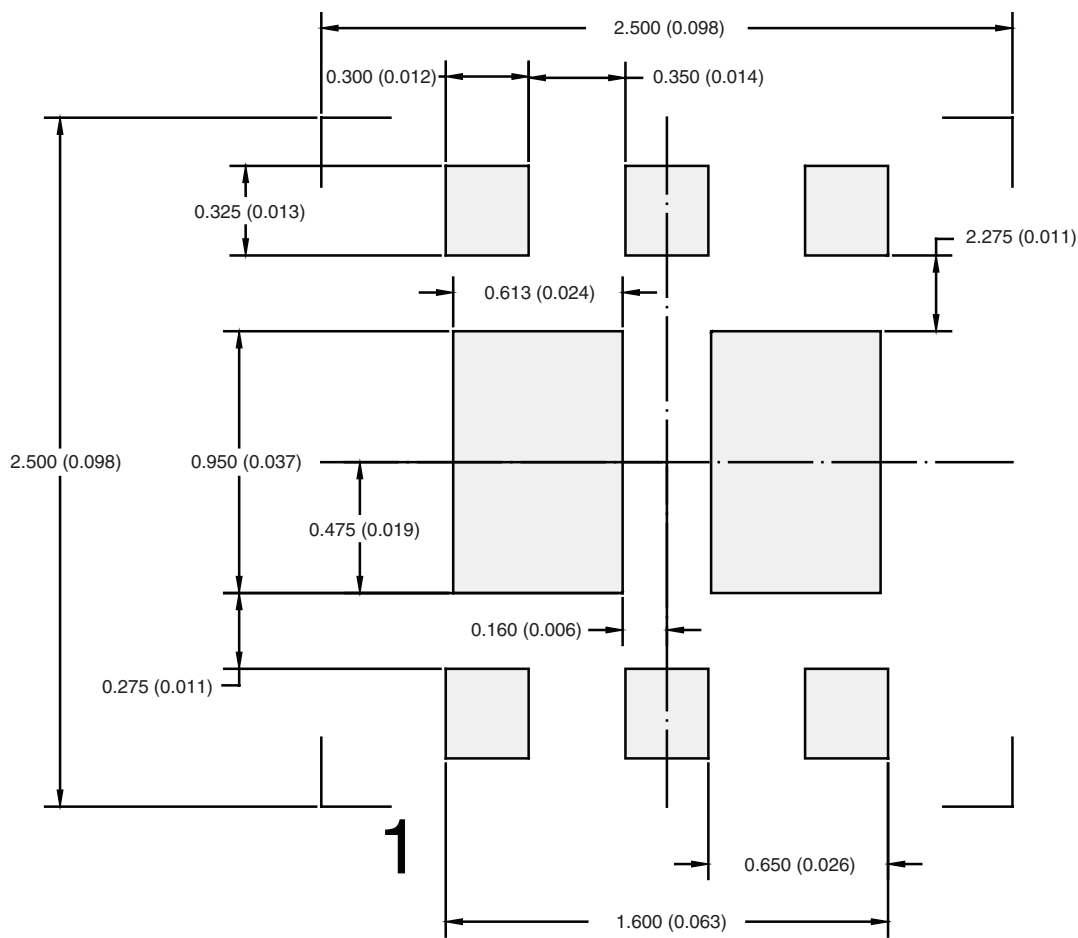


- Notes:
 1. All dimensions are in millimeters
 2. Package outline exclusive of mold flash and metal burr
 3. Package outline inclusive of plating

DIM	SINGLE PAD						DUAL PAD					
	MILLIMETERS			INCHES			MILLIMETERS			INCHES		
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max
A	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032
A1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002
b	0.23	0.30	0.38	0.009	0.012	0.015	0.23	0.30	0.38	0.009	0.012	0.015
C	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010
D	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
D1	0.85	0.95	1.05	0.033	0.037	0.041	0.513	0.613	0.713	0.020	0.024	0.028
D2	0.135	0.235	0.335	0.005	0.009	0.013						
E	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
E1	1.40	1.50	1.60	0.055	0.059	0.063	0.85	0.95	1.05	0.033	0.037	0.041
E2	0.345	0.395	0.445	0.014	0.016	0.018						
E3	0.425	0.475	0.525	0.017	0.019	0.021						
e	0.65 BSC			0.026 BSC			0.65 BSC			0.026 BSC		
K	0.275 TYP			0.011 TYP			0.275 TYP			0.011 TYP		
K1	0.400 TYP			0.016 TYP			0.320 TYP			0.013 TYP		
K2	0.240 TYP			0.009 TYP			0.252 TYP			0.010 TYP		
K3	0.225 TYP			0.009 TYP								
K4	0.355 TYP			0.014 TYP								
L	0.175	0.275	0.375	0.007	0.011	0.015	0.175	0.275	0.375	0.007	0.011	0.015
T							0.05	0.10	0.15	0.002	0.004	0.006

ECN: C-07431 – Rev. C, 06-Aug-07
 DWG: 5934

RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Dual



Dimensions in mm/(Inches)

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APPLICATION NOTE



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